

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**RECEIVED
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JUN 25 2007**

Application No. : 09/884,429 Confirmation No.: 9951
Applicant(s) : David Chazan et al.
Filing Date : 06/18/2001
TC/A.U. : 1743
Examiner : Brian R. Gordon

Docket No. : 100/09110
Customer No. : 021569
Title : Methods and Devices for Enhancing Bonded Substrate Yields and
Regulating Temperature

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Sir:

In response to the Office action mailed February 23, 2007, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.